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Kind regards,

Team Nexperia



# PBSS5620PA

# 20 V, 6 A PNP low V<sub>CEsat</sub> (BISS) transistor Rev. 01 — 13 April 2010

**Product data sheet** 

## **Product profile**

#### 1.1 General description

PNP low V<sub>CEsat</sub> Breakthrough In Small Signal (BISS) transistor, encapsulated in an ultra thin SOT1061 leadless small Surface-Mounted Device (SMD) plastic package with medium power capability.

NPN complement: PBSS4620PA.

#### 1.2 Features and benefits

- Low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability I<sub>C</sub> and I<sub>CM</sub>
- Smaller required Printed-Circuit Board (PCB) area than for conventional transistors
- Exposed heat sink for excellent thermal and electrical conductivity
- Leadless small SMD plastic package with medium power capability

## 1.3 Applications

- Loadswitch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

#### 1.4 Quick reference data

Table 1. Quick reference data

| Symbol             | Parameter                               | Conditions                                       | Min          | Тур | Max       | Unit |
|--------------------|---|--|--------------|-----|-----------|------|
| $V_{CEO}$          | collector-emitter voltage               | open base  | -            | -   | -20       | V    |
| $I_{C}$            | collector current                       |  | -            | -   | -6        | Α    |
| I <sub>CM</sub>    | peak collector current                  | single pulse; $t_p \le 1 \text{ ms}$             | -            | -   | <b>-7</b> | Α    |
| R <sub>CEsat</sub> | collector-emitter saturation resistance | $I_C = -6 \text{ A};$<br>$I_B = -300 \text{ mA}$ | <u>[1]</u> - | 39  | 58        | mΩ   |

<sup>[1]</sup> Pulse test:  $t_p \le 300 \ \mu s; \ \delta \le 0.02.$ 



# 2. Pinning information

Table 2. Pinning

|             | 3           |                      |                |
|-------------|-------------|----------------------|----------------|
| Pin         | Description | Simplified outline   | Graphic symbol |
| 1           | base        |                      | _              |
| 2           | emitter     | 3                    | 3<br>          |
| 3 collector |             | 1 — 2                |                |
|             |             | 1 2                  | sym013         |
|             |             | Transparent top view |                |

# 3. Ordering information

Table 3. Ordering information

| Type number | Package | Package  |         |  |  |
|-------------|---------|--|---------|--|--|
|             | Name    | Description  | Version |  |  |
| PBSS5620PA  | HUSON3  | plastic thermal enhanced ultra thin small outline package; no leads; three terminals; body $2\times2\times0.65$ mm | SOT1061 |  |  |

## 4. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PBSS5620PA  | AA           |

## 5. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

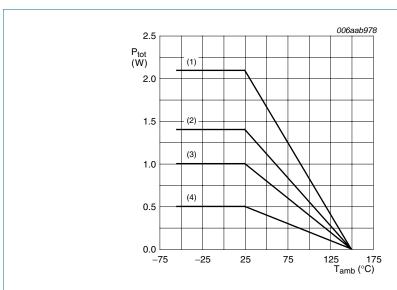
| Symbol           | Parameter                 | Conditions                           | Min          | Max       | Unit |
|------------------|---------------------------|--------------------------------------|--------------|-----------|------|
| $V_{CBO}$        | collector-base voltage    | open emitter                         | -            | -20       | V    |
| $V_{CEO}$        | collector-emitter voltage | open base                            | -            | -20       | V    |
| $V_{EBO}$        | emitter-base voltage      | open collector                       | -            | <b>-7</b> | V    |
| I <sub>C</sub>   | collector current         |                                      | -            | -6        | Α    |
| I <sub>CM</sub>  | peak collector current    | single pulse; $t_p \le 1 \text{ ms}$ | -            | <b>-7</b> | Α    |
| I <sub>B</sub>   | base current              |                                      | -            | -600      | mA   |
| P <sub>tot</sub> | total power dissipation   | T <sub>amb</sub> ≤ 25 °C             | <u>[1]</u> _ | 500       | mW   |
|                  |                           |                                      | [2] _        | 1         | W    |
|                  |                           |                                      | [3] _        | 1.4       | W    |
|                  |                           |                                      | [4] _        | 2.1       | W    |

Table 5. Limiting values ...continued

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter            | Conditions | Min | Max  | Unit |
|------------------|----------------------|------------|-----|------|------|
| Tj               | junction temperature |            | -   | 150  | °C   |
| T <sub>amb</sub> | ambient temperature  |            | -55 | +150 | °C   |
| T <sub>stg</sub> | storage temperature  |            | -65 | +150 | °C   |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.



- (1) Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint
- (2) FR4 PCB, mounting pad for collector 6 cm<sup>2</sup>
- (3) FR4 PCB, mounting pad for collector 1 cm<sup>2</sup>
- (4) FR4 PCB, standard footprint

Fig 1. Power derating curves

## 6. Thermal characteristics

Table 6. Thermal characteristics

| Symbol  | Parameter   | Conditions   | Min          | Тур | Max | Unit |
|---|-------------|--------------|--------------|-----|-----|------|
| $R_{th(j-a)}$ thermal resistance from junction to ambient | in free air | <u>[1]</u> _ | -            | 250 | K/W |      |
|   |             | [2] _        | -            | 125 | K/W |      |
|   |             | [3]          | -            | 90  | K/W |      |
|   |             |              | <u>[4]</u> _ | -   | 60  | K/W  |

- [1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for collector 6 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

PBSS5620PA\_1

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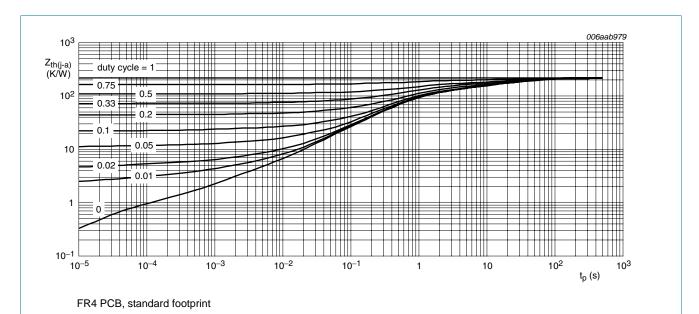


Fig 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

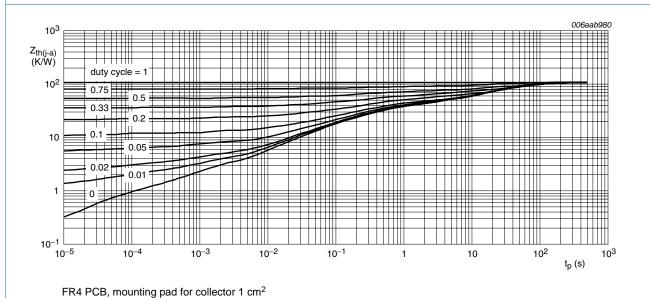


Fig 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

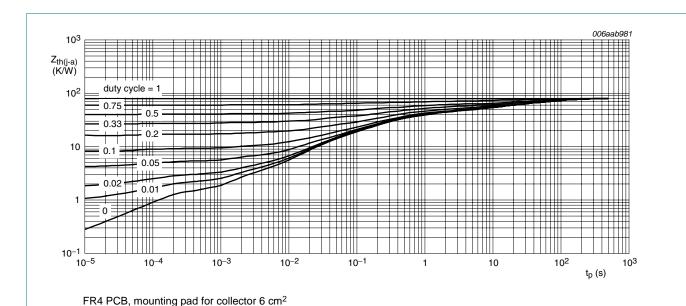
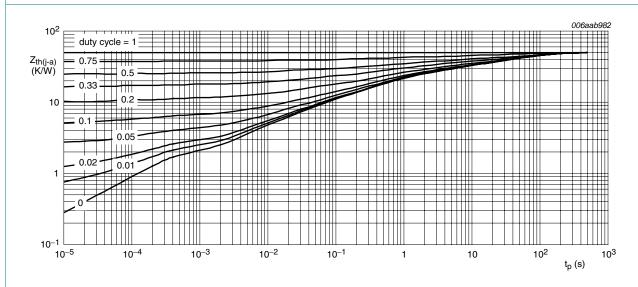


Fig 4. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

Fig 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

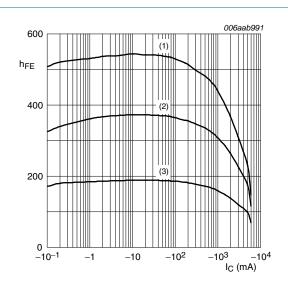
## 7. Characteristics

Table 7. Characteristics

 $T_{amb} = 25 \, ^{\circ}\text{C}$  unless otherwise specified.

| Symbol             | Parameter                               | Conditions   | Min          | Тур   | Max  | Unit |
|--------------------|---|--|--------------|-------|------|------|
| I <sub>CBO</sub>   | collector-base                          | $V_{CB} = -16 \text{ V}; I_E = 0 \text{ A}$                                | -            | -     | -100 | nA   |
|                    | cut-off current                         | $V_{CB} = -16 \text{ V}; I_E = 0 \text{ A};$<br>$T_j = 150 \text{ °C}$     | -            | -     | -50  | μА   |
| I <sub>CES</sub>   | collector-emitter<br>cut-off current    | $V_{CE} = -16 \text{ V}; V_{BE} = 0 \text{ V}$                             | -            | -     | -100 | nA   |
| I <sub>EBO</sub>   | emitter-base<br>cut-off current         | $V_{EB} = -5 \text{ V}; I_{C} = 0 \text{ A}$                               | -            | -     | -100 | nA   |
| h <sub>FE</sub>    | DC current gain                         | $V_{CE} = -2 V$  | <u>[1]</u>   |       |      |      |
|                    |   | $I_{\rm C} = -0.5 \; {\rm A}$  | 230          | 345   | -    |      |
|                    |   | $I_C = -1 A$   | 220          | 320   | -    |      |
|                    |   | I <sub>C</sub> = −2 A  | 190          | 275   | -    |      |
|                    | $I_{\rm C} = -6  {\rm A}$               | 110  | 155          | -     |      |      |
| V <sub>CEsat</sub> | collector-emitter                       | $I_C = -0.5 \text{ A}; I_B = -50 \text{ mA}$                               | <u>[1]</u> - | -25   | -40  | mV   |
|                    | saturation voltage                      | $I_C = -1 A$ ; $I_B = -50 \text{ mA}$                                      | [1] -        | -50   | -80  | mV   |
|                    |   | $I_C = -1 A$ ; $I_B = -10 \text{ mA}$                                      | [1] -        | -80   | -130 | mV   |
|                    |   | $I_C = -2 \text{ A}; I_B = -20 \text{ mA}$                                 | [1] -        | -135  | -210 | mV   |
|                    |   | $I_C = -3 \text{ A}; I_B = -30 \text{ mA}$                                 | [1] -        | -215  | -325 | mV   |
|                    |   | $I_C = -4 \text{ A}; I_B = -400 \text{ mA}$                                | [1] -        | -150  | -230 | mV   |
|                    |   | $I_C = -6 \text{ A}; I_B = -300 \text{ mA}$                                | [1] -        | -235  | -350 | mV   |
| R <sub>CEsat</sub> | collector-emitter saturation resistance | $I_C = -6 \text{ A}; I_B = -300 \text{ mA}$                                | [1] -        | 39    | 58   | mΩ   |
| V <sub>BEsat</sub> | base-emitter                            | $I_C = -1 A$ ; $I_B = -10 \text{ mA}$                                      | [1] -        | -0.75 | -0.9 | V    |
|                    | saturation voltage                      | $I_C = -6 \text{ A}; I_B = -300 \text{ mA}$                                | [1] -        | -1.03 | -1.1 | V    |
| $V_{BEon}$         | base-emitter<br>turn-on voltage         | $V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}$                              | [1] -        | -0.76 | -0.9 | V    |
| t <sub>d</sub>     | delay time                              | $V_{CC} = -9 \text{ V}; I_C = -2 \text{ A};$                               | -            | 19    | -    | ns   |
| t <sub>r</sub>     | rise time                               | $I_{Bon} = -0.1 \text{ A};$<br>$I_{Boff} = 0.1 \text{ A}$                  | -            | 59    | -    | ns   |
| t <sub>on</sub>    | turn-on time                            | Boff - U. I A  | -            | 78    | -    | ns   |
| t <sub>s</sub>     | storage time                            |  | -            | 265   | -    | ns   |
| t <sub>f</sub>     | fall time                               |  | -            | 55    | -    | ns   |
| t <sub>off</sub>   | turn-off time                           |  | -            | 320   | -    | ns   |
| f⊤                 | transition frequency                    | $V_{CE} = -10 \text{ V};$ $I_{C} = -100 \text{ mA};$ $f = 100 \text{ MHz}$ | 50           | 80    | -    | MHz  |
| C <sub>c</sub>     | collector capacitance                   | $V_{CB} = -10 \text{ V};$ $I_E = i_e = 0 \text{ A}; f = 1 \text{ MHz}$     | -            | 75    | 90   | pF   |

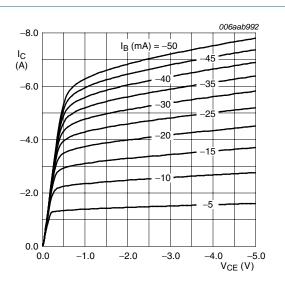
<sup>[1]</sup> Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 



$$V_{CE} = -2 V$$

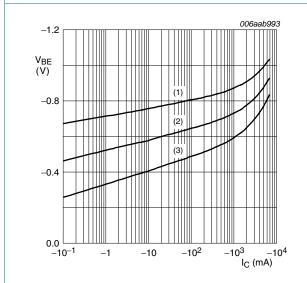
- (1)  $T_{amb} = 100 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = -55 \, ^{\circ}C$

Fig 6. DC current gain as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$ 

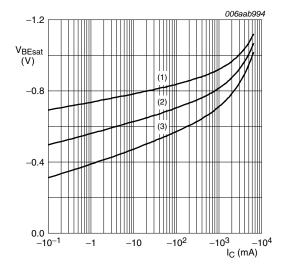
Fig 7. Collector current as a function of collector-emitter voltage; typical values





- (1)  $T_{amb} = -55 \,^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

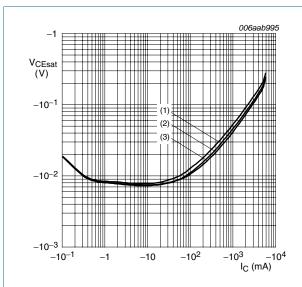
Fig 8. Base-emitter voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 20$ 

- (1)  $T_{amb} = -55 \, ^{\circ}C$
- (2)  $T_{amb} = 25 \, ^{\circ}C$
- (3)  $T_{amb} = 100 \, ^{\circ}C$

Fig 9. Base-emitter saturation voltage as a function of collector current; typical values



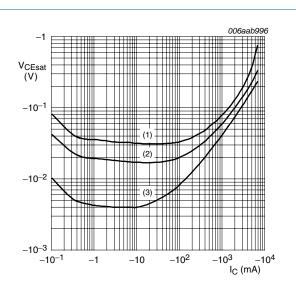
$$I_{\rm C}/I_{\rm B} = 20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 10. Collector-emitter saturation voltage as a function of collector current; typical values

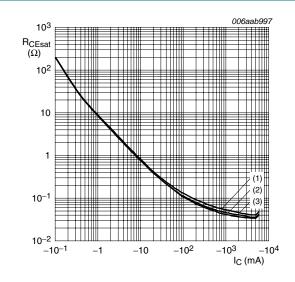


(1) 
$$I_C/I_B = 100$$

(2) 
$$I_C/I_B = 50$$

(3)  $I_C/I_B = 10$ 

Fig 11. Collector-emitter saturation voltage as a function of collector current; typical values



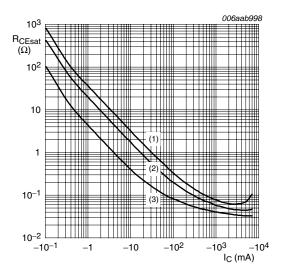
$$I_{\rm C}/I_{\rm B}=20$$

(1) 
$$T_{amb} = 100 \, ^{\circ}C$$

(2) 
$$T_{amb} = 25 \, ^{\circ}C$$

(3)  $T_{amb} = -55 \, ^{\circ}C$ 

Fig 12. Collector-emitter saturation resistance as a function of collector current; typical values



$$T_{amb} = 25 \, ^{\circ}C$$

(1) 
$$I_C/I_B = 100$$

(2)  $I_C/I_B = 50$ 

(3)  $I_C/I_B = 10$ 

Fig 13. Collector-emitter saturation resistance as a function of collector current; typical values

## 8. Test information

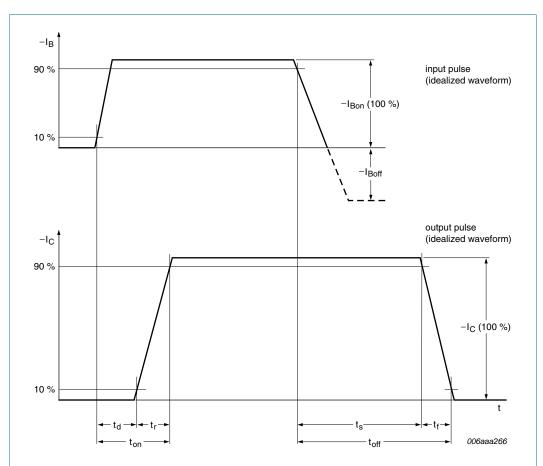
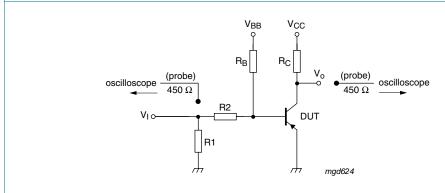


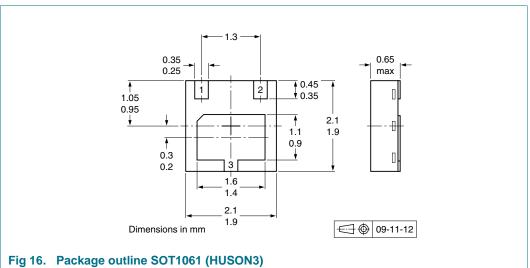
Fig 14. BISS transistor switching time definition



 $V_{CC} = -9 \text{ V; } I_{C} = -2 \text{ A; } I_{Bon} = -0.1 \text{ A; } I_{Boff} = 0.1 \text{ A}$ 

Fig 15. Test circuit for switching times

# Package outline



# 10. Packing information

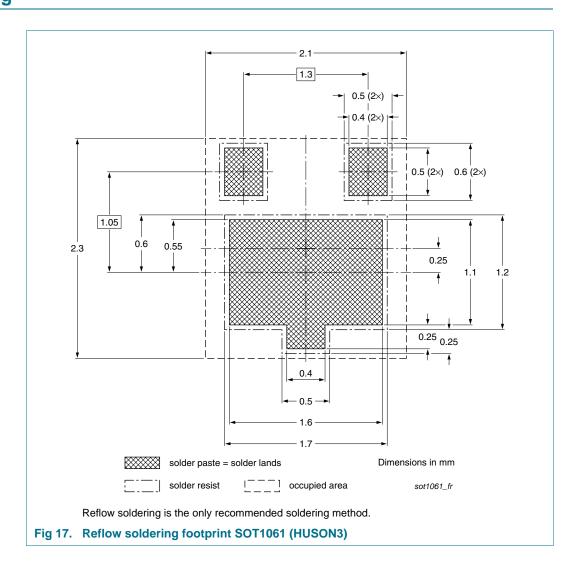
Table 8. **Packing methods** 

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

| Type number | Package | Description                    | Packing quantity |
|-------------|---------|--------------------------------|------------------|
|             |         |                                | 3000             |
| PBSS5620PA  | SOT1061 | 4 mm pitch, 8 mm tape and reel | -115             |

<sup>[1]</sup> For further information and the availability of packing methods, see Section 14.

# 11. Soldering



# 12. Revision history

#### Table 9. Revision history

| Document ID  | Release date | Data sheet status  | Change notice | Supersedes |
|--------------|--------------|--------------------|---------------|------------|
| PBSS5620PA_1 | 20100413     | Product data sheet | -             | -          |

## 13. Legal information

#### 13.1 Data sheet status

| Document status[1][2]          | Product status[3] | Definition  |
|--------------------------------|-------------------|---|
| Objective [short] data sheet   | Development       | This document contains data from the objective specification for product development. |
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NXP Semiconductors PBSS5620PA

#### 20 V, 6 A PNP low V<sub>CEsat</sub> (BISS) transistor

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# PBSS5620PA

## 20 V, 6 A PNP low V<sub>CEsat</sub> (BISS) transistor

## 15. Contents

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